

Vishay Siliconix

P-Channel 60-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	r _{DS(on)} (Ω)	I _D (A) ^d	Q _g (Typ.)		
- 60	0.019 at V _{GS} = - 10 V	- 55	76		
- 60	0.025 at V _{GS} = - 4.5 V	- 48	70		

FEATURES

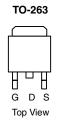
• TrenchFET[®] Power MOSFET

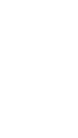
GO

s

P-Channel MOSFET







Ordering Information: SUM55P06-19L SUM55P06-19L-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATINGS T_{C}	= 25 °C, unless other	wise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 60	v		
Gate-Source Voltage	V _{GS}	± 20	v		
Continuous Durin Connect ^d (T. 175 °C)	T _C = 25 °C	L	- 55	•	
Continuous Drain Current ^d ($T_J = 175 \ ^{\circ}C$)	T _C = 125 °C	I _D	- 31		
Pulsed Drain Current	I _{DM}	- 150	A		
Avalanche Current	L = 0.1 mH	I _{AS}	- 45		
Single Pulse Avalanche Energy ^a		E _{AS}	101	mJ	
Devery Directory	T _C = 25 °C	Р	125 ^c	w	
Power Dissipation	T _A = 25 °C ^b	P _D	3.75		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Limit	Unit		
Junction-to-Ambient	PCB Mount ^b	R _{thJA}	40	°C/W		
Junction-to-Case		R _{thJC}	1.2	0/10		

Notes:

a. Duty cycle \leq 1%.

b. When Mounted on 1" square PCB (FR-4 material).

c. See SOA curve for voltage derating.

d. Limited by package.

* Pb containing terminations are not RoHS compliant, exemptions may apply.

SUM55P06-19L

Vishay Siliconix



SPECIFICATIONS T _J = 25 ° Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static	Symbol	Test conditions	IVIIII.	Typ.	wax.	Unit	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = - 250 μA	- 60				
Gate-Threshold Voltage	V _{GS(th)}				- 3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	- 1		± 100	nA	
	.035	$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	-	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$			- 50	μA	
	.033	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 175 ^{\circ}\text{C}$			- 250	- ^µ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 V, V_{GS} = -10 V$	- 120			A	
	D(01)	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -30 \text{ A}$		0.015	0.019		
		$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -30 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		0.0.0	0.033	033 Ω	
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -30 \text{ A}, \text{ T}_{J} = 175 \text{ °C}$			0.041		
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -20 \text{ A}$		0.020	0.025	-	
Forward Transconductance ^a	g _{fs}	V _{DS} = - 15 V, I _D = - 50 A	20			S	
Dynamic ^b	013	50 , 5					
Input Capacitance	C _{iss}			3500		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 25 V, f = 1 MHz		390			
Reverse Transfer Capacitance	C _{rss}			290			
Total Gate Charge ^c	Qq			76	115		
Gate-Source Charge ^c	Q _{gs}	V _{DS} = - 30 V, V _{GS} = - 10 V, I _D = - 55 A		16		nC	
Gate-Drain Charge ^c	Q _{gd}			19			
Gate Resistance	R _a	f = 1.0 MHz		5.2		Ω	
Turn-On Delay Time ^c	t _{d(on)}			12	20		
Rise Time ^c	t _r	$V_{DD} = -30 \text{ V}, \text{ R}_1 = 0.54 \Omega$		15	25	- ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -55 \text{ A}, V_{\text{GEN}} = -10 \text{ V}, R_{\text{g}} = 2.5 \Omega$		80	120		
Fall Time ^c	t _f			230	350		
Source-Drain Diode Ratings and Cha	· ·	- 25 °Cb		200	000		
	1	C = 23 C		1	110		
Continuous Current	I _S				- 110	А	
Pulsed Current	I _{SM}	I _F = - 50 A, V _{GS} = 0 V		10	- 240		
Forward Voltage ^a	V _{SD}	$I_{F} = -50 \text{ A}, V_{GS} = 0 \text{ V}$		- 1.0	- 1.5	V	
Reverse Recovery Time	t _{rr}	L = 50 A di/dt 100 A/va		45	68	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 50 A, di/dt = 100 A/μs		- 2.6	4.0	A	
Reverse Recovery Charge	Q _{rr}			0.059	0.136	μC	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

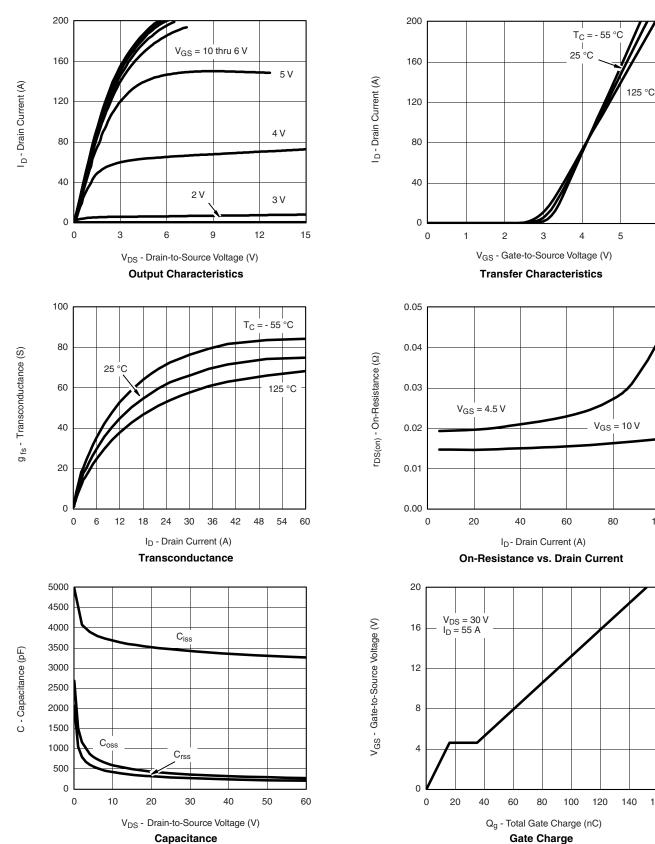


SUM55P06-19L

Vishay Siliconix

6

100



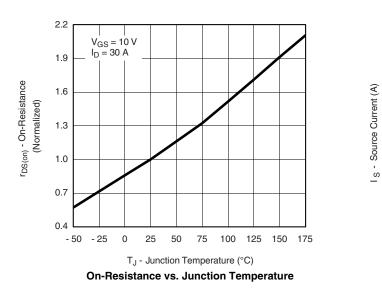
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

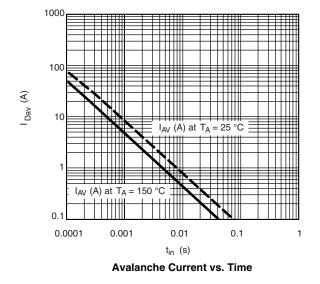
Document Number: 73059 S-80272-Rev. C, 11-Feb-08 160

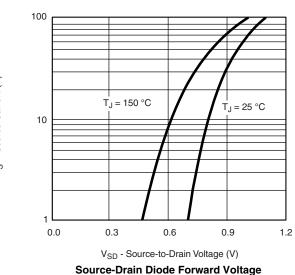
VISHAY.

Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

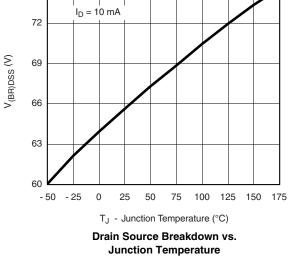


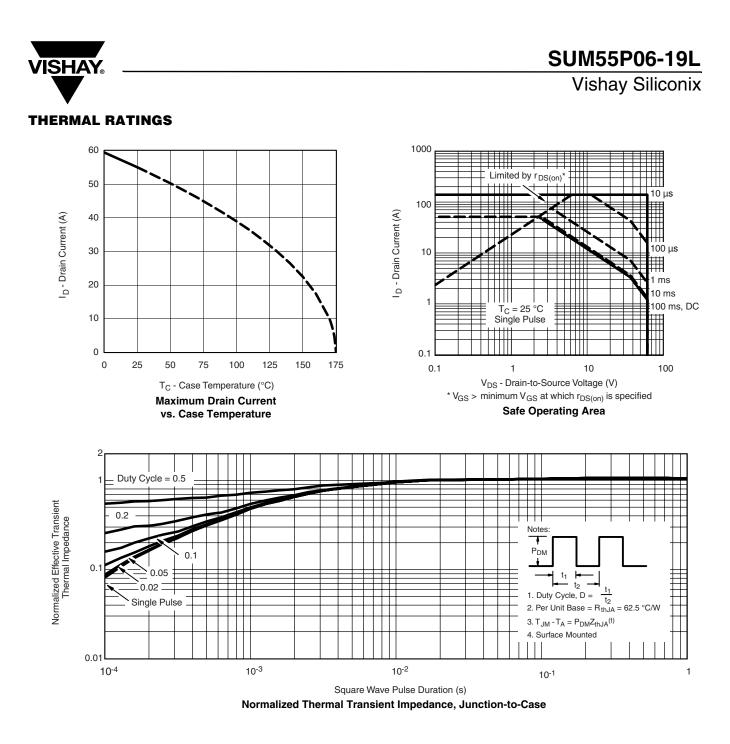




I_D = 10 mA

75



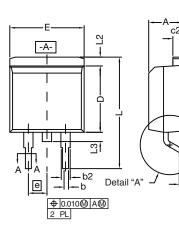


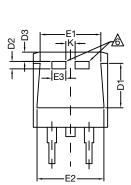


Package Information

Vishay Siliconix

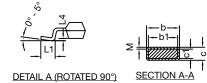
TO-263 (D²PAK): 3-LEAD





-B-

С



		INCHES		MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.	
	А	0.160	0.190	4.064	4.826	
	b	0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
с*	Thin lead	0.013	0.018	0.330	0.457	
C	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
	D2	0.038	0.042	0.965	1.067	
D3		0.045	0.055	1.143	1.397	
	E	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
	E2	0.355	0.375	9.017 9.525		
	E3	0.072	0.078	1.829	1.981	
	е	0.100 BSC		2.54	BSC	
	К	0.045	0.055	1.143	1.397	
	L	0.575	0.625	14.605	15.875	
	L1	0.090	0.110	2.286	2.794	
	L2	0.040	0.055	1.016	1.397	
	L3	0.050	0.070	1.270	1.778	
	L4	0.010 BSC		0.254 BSC		
	М	-	0.002	- 0.050		
ECN: T10-0738-Rev. J, 03-Jan-11 DWG: 5843						

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB.
- Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.